

Title (en)  
POLYAMIDE COMPOSITION FOR MOLDING

Title (de)  
POLYAMIDFORMMASSEN

Title (fr)  
COMPOSITION POLYAMIDE POUR MOULAGE

Publication  
**EP 1137713 A1 20011004 (EN)**

Application  
**EP 99971014 A 19991022**

Priority  
• JP 30283398 A 19981023  
• US 9924767 W 19991022

Abstract (en)  
[origin: WO0024830A1] A polyamide composition for molded products having thin-wall parts and for connectors for use in automobiles, containing:  
A) 100 wt parts of a semi-aromatic polyamide having a melting point of 280 to 320 DEG C and a glass transition temperature of 95 to 115 DEG C, wherein the amount of aromatic monomer constituting the polyamide is at least 30 mol %, and B) 1 to 70 wt parts of an impact resistance agent composed mainly of a modified polyolefin that has been graft-modified by means of a carboxylic acid or a carboxylic anhydride.

IPC 1-7  
**C08L 77/06**; H01B 3/30; H01R 13/46; C08L 77/00

IPC 8 full level  
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**C08L 2201/08** (2013.01 - KR); **H01R 13/46** (2013.01 - EP)

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